

The impact of thermal boundary resistance in opto-electronic devices

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www.fastaccessproject.eu



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Presentation outline

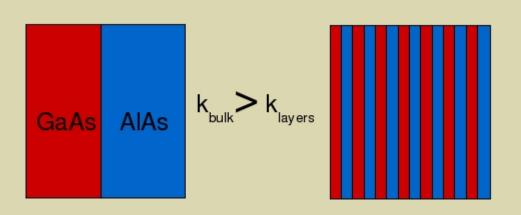


- Heat flow through structures with multiple epitaxial layers
 - Theory of Thermal Boundary Resistance (TBR)
- Examples:
 - Example 1 Thermal conductivity of a VCSEL mirror
 - Example 2 Electron/phonon heat flux over a TBR
 - Example 3 High brightness 975nm edge-emitting laser
 - Full electro-opto-thermal simulations
 - Impact on L-I curves
- Conclusions

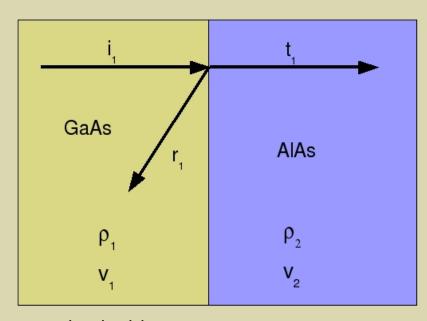
Thermal conductivity of superlattices



- GaAs/AlAs superlattices have a much lower thermal conductivity than one would predict from the bulk values alone.¹ (3x-10x lower)
 - Bulk GaAs/AlAs thermal conductivity = 58.4m⁻¹K⁻¹
 - Superlattices thermal conductivity = 5.0m⁻¹K⁻¹



- This effect is mainly due to phonon scattering/reflections at material interfaces
- TBR first observed by Kapitza (1941)²



i = incident wave

r = reflected wave

t = transmitted wave

[1] W.S. Capinski *et. al.,* Phys. Rev. B Vol. 59, No. 12, p.8105 (1999). [2] Collected papers of P.L. Kapitza, Vol. 2, Pergamon, Oxford, p. 581 (1965).

How does structure size affect the conductivity?



Consider a superlattice with a period L, where Λ is the average phonon mean free path (\approx 20nm)

One can distinguish two regimes:

- 1) $L \approx \Lambda$ A bulk thermal conductivity can be used between the interfaces by placing a thermal resistance at each boundary (TBR)
- 2) L « Λ The situation becomes more complicated with phonons reflecting off multiple layers and gaps forming in the dispersion relations
- > Edge-emitting lasers fall within the L≈A regime

What values of TBR should be used?



- Values of TBR are depend on:
 - The acoustic mismatch of the materials
 - Masses Elastic constants -> Speed of sound in materials
 - Similar to Snell's law
- The quality of epitaxial interfaces
- Layer thickness
- Exhaustive experimental characterization of the effect is not complete
 - Still no real consensus on microscopic models for TBR
- Diffuse Mismatch Model (DMM) is used in this work
 - Has shown some agreement with experiment
- Typical values (m^2K/W) : $GaAs/AlGaAs\approx1.2x10^{-9}$, $GaN/Si^{[1]}\approx7x10^{-8}$, $GaN/Si^{[1]}\approx7x10^{-8}$, $GaN/Si^{[1]}\approx7-8x10^{-8}$

Discretization scheme for inclusion of TBR



 The lattice heat equation is commonly solved in thermal models:

$$\rho_L C_L \frac{\partial T}{\partial t} = \nabla \cdot (k \nabla T) + H$$

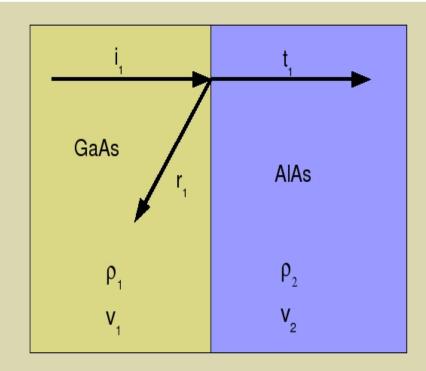
 However, because of abrupt thermal resistances at epitaxial interfaces one must solve:

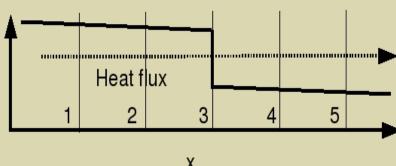
(1)
$$\left(\frac{\partial T}{\partial x}\right)_{r+1/2}^{3} k_{1} = k_{2} \left(\frac{\partial T}{\partial x}\right)_{r+1/2}^{4}$$

 Introduce a step in temperature proportional to the boundary resistance:

(2)
$$T_{r+1/2}^{(3)} - T_{r+1/2}^{(4)} = Rk_2 \left(\frac{\partial T}{\partial x}\right)_{r+1/2}^3$$

 Adapted¹ from a scheme to model discontinuities Quasi-TE modes of semiconductor waveguides²

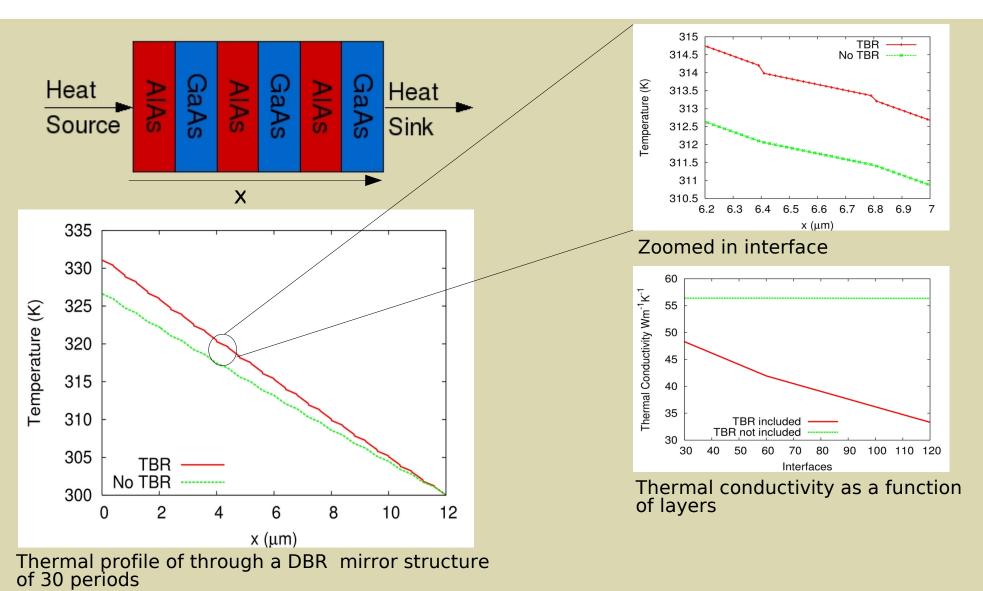




1) R. MacKenzie et.al. Phys. Stat.Sol. c accepted for publication, 2) M.S. Stern, IEE Proc. Vol. 135, pp. 56-63 (1998)

Example 1: Structures with multiple layers





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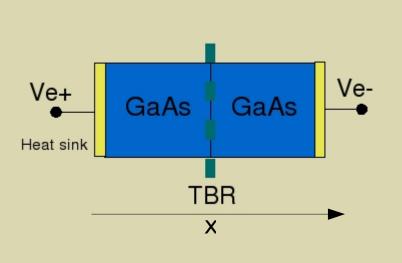
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Example 2: Electron and lattice heat flux within a semiconductor slab



Slab of GaAs with a TBR at the center of it, possibly caused by defects

- Doped with 1x10²³m⁻³ donors
- Apply voltage across device
- Examine interplay of electron heat, lattice heat and TBR

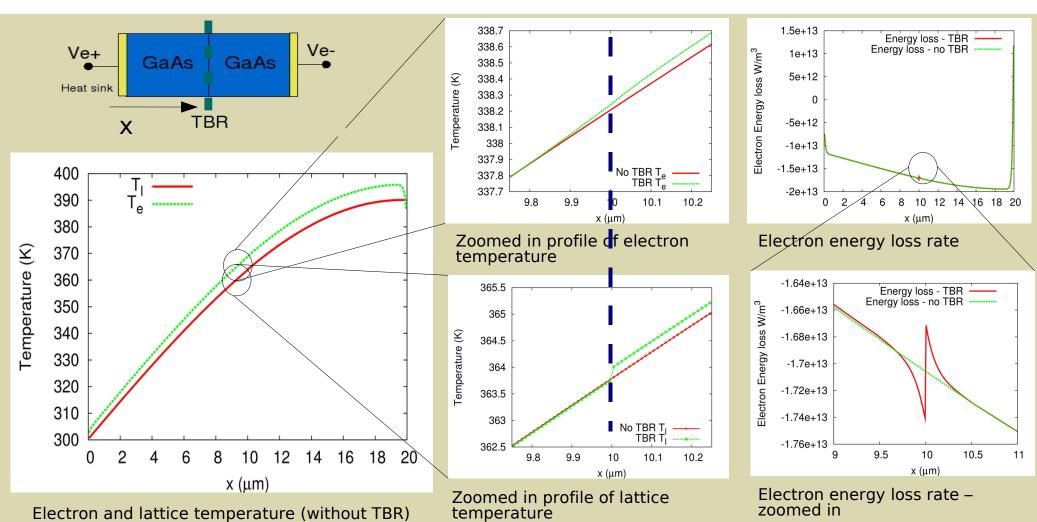


Equations solved:

- Lattice heat equation
- Current continuity equation
- Energy balance equation for electrons
 - (0th-2nd moments of B.T.E. -> Hydrodynamic transport model)
- Possion's equation

Example 2: Electron and lattice heat flux within a semiconductor wire





Discrete step in lattice temperature, gradual decrease in electron temperature

Example 3: TBR in high-power edge-emitting lasers



QW material: In_xGa_{x-1}As

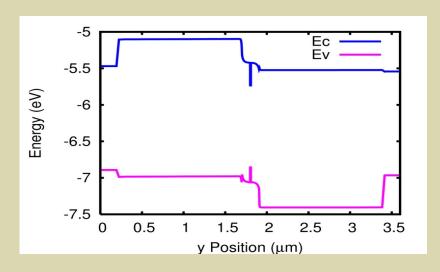
Number of QWs: 1

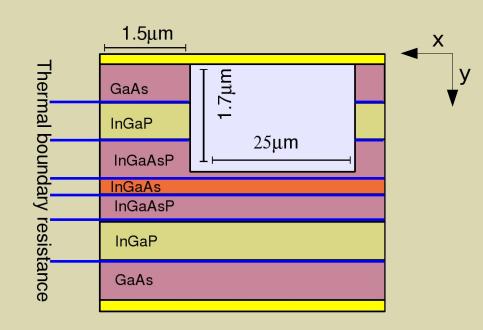
Front facet output power: $P_{out} = 1 - 1.2 \text{ W}$

Device length: 2mm

Back facet coating: 0.90

Front facet coating: 0.03





- Half space simulations
- TBR introduced at each epitaxial interface
- Typical applications
 - Pumping EDFAs @ 980nm

Device simulator

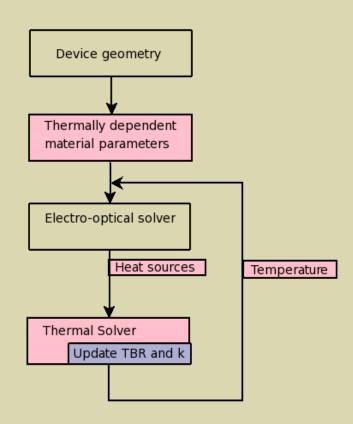


Electro-thermal Model

- Bipolar 2D Drift Diffusion (DD) model 0th and 1st moments of the Boltzmann Transport Equation (BTE)
- Poisson's equation
- QW capture/escape equations the QW
- 4 temperature model for the QW
 - Electron, hole, LO-phonon and lattice temperatures
- 2D lattice heat equation
 - Heat sources derived from 2nd moment of BTE

Optical Model

- Photon rate equation
- Valance band structure calculated using 4x4 band k.p
- Parabolic band model for the conduction band
- Fermi's Golden rule used to calculate the stimulated and spontaneous emission rates
- 2D mode solver

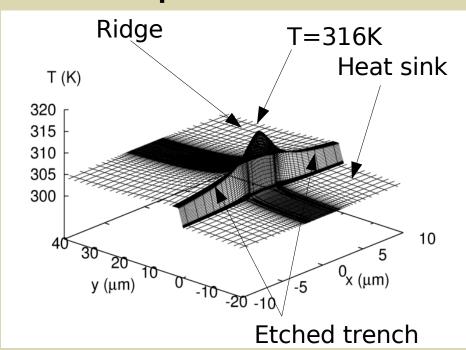


All equations solved using Newton's method

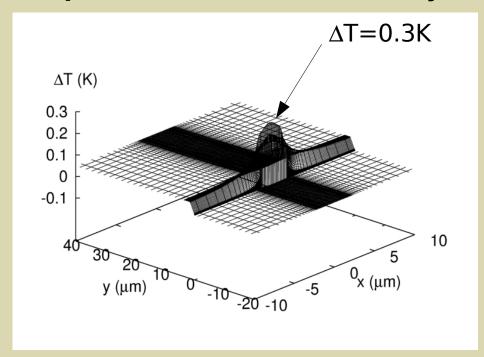
2D thermal profiles and the impact of TBR



2D thermal profile



Temperature increase caused by TBR



- A sudden increase in the temperature is observed
- An increase of up to 0.3K is observed in the QW

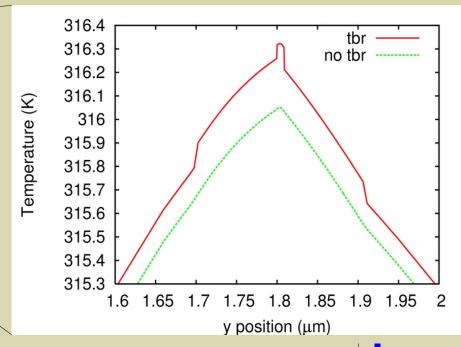
Vertical thermal profile with and without TBR



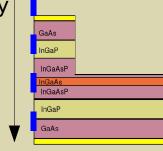
Vertical thermal profile

318 tbr no tbr -----316 314 Temperature (K) 312 310 308 306 304 302 2 6 8 10 y position (µm)

Zoomed in profile



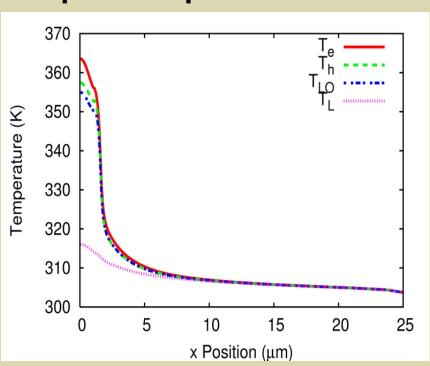
- Up to half a degree difference in peak temperature of device
- Small temperature differences are important for accurate models



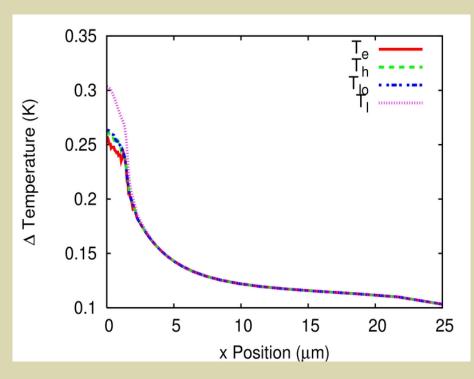
Horizontal electron, hole, LO-phonon and lattice temperatures in the QW



Temperature profiles



Change in QW temperatures due to TBR

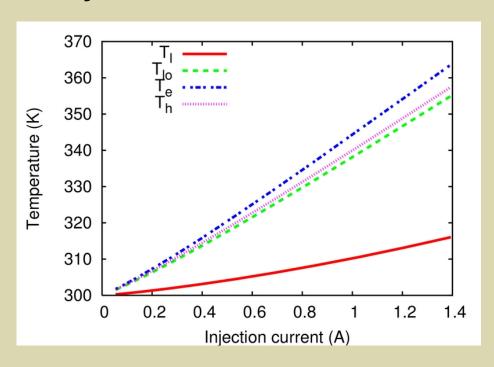


- The lattice temperature is affected most by the TBR
 - Electron, hole and LO-phonon temperatures are dominated by injection current and radiative emission

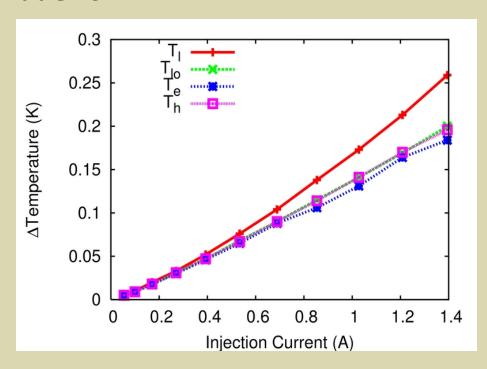
Impact of TBR on QW temperature



QW Temperatures as a function of injection current



Difference in QW temperatures due to TBR



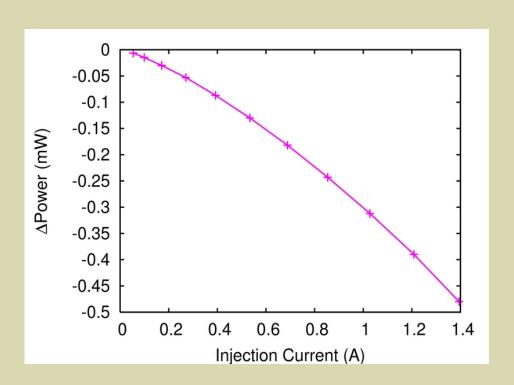
- An increase in QW temperature of up to 0.25K is observed
 - Lattice temperature affected more than that of the electron/hole/LOphonon populations

Impact of TBR on front facet power



L-I curve for heatsink temperature held at 300K

Impact TBR has on L-I curves



A decrease of up to 0.5mW in optical power is expected due to TBR

Conclusions



- Multi layer structures
 - TBR has a larger impact on multi layer structures
 - However, change in phonon density of states must be taken in to account when layer thickness is comparable to phonon mean free path.
 - Electron heat/Lattice heat/TBR interaction
 - Lattice heat affected by TBR / Electron heat not abrupt
- High power 980nm ridge waveguide lasers
 - As bias current is increased -> more heat generation -> more heat flux -> TBR has a larger impact
 - Electron/hole/LO-phonon temperatures are not affected as much as lattice temperatures by TBR
 - TBR has been shown to increase the predicted temperature of 980nm EELs by up to 0.3K
 - A 0.5mW decrease in optical power is predicted
 - Need for more *more accurate* TBR values Ideally from experiment
 - Better numerical models for calculation of TBR are also needed